# TECHNICAL DATA SHEET



23+/-2°C and 50+/-5%

humidity

24 hr

**Alkoxy** 

**Paste** 

15 min

White

560 %

220 °C / 428 °F

35

BS ISO 2781 1.38 g/cm3

**ISO 37** 

ASTM D

2240-95

Yes

# **AS1720WCN** 1 Part Non-Corrosive Neutral Cure Adhesive Sealant and Potting Material (Electronic Grade)

**Uncured Product** 

Cure Through to 3 mm Depth

Cure Profile

Cure Type

Rheology

Color

Density

Self Bonding

**Cured Product** 

Elongation at Break

Hardness Shore A

Max Working Temp

Tack Free Time / Skin

Formation at 23°C/73°F

#### Description **Property Test Method Value**

This is a non-corrosive, neutral cure, 1-part, RTV (Room Temperature Vulcanising) silicone adhesive sealant. It is one in a range of Alkoxy cure products which are solvent free. It exhibits excellent primerless adhesion to many substrates and cures at room temperature when in contact with atmospheric moisture to form a tough rubber. This product will not corrode copper or its alloys and is suitable for use with electronic components.

## **Key Features**

- Neutral cure
- Non corrosive to sensitive substrates
- Non slumping paste
- Adhesive to most substrates

#### Application

Electronic assemblies, automotive

### **Use and Cure Information**

This product is a ready for use 1 Part system. If supplied in cartridges it can be applied using either manual or pneumatic dispensing guns. It can also be applied from bulk containers using conventional drum dispensing equipment.

All surfaces to which the sealant is to be applied should be clean, dry and free from grease, dirt, and loose material. Priming of surfaces is not normally required. If using as an adhesive, it should be applied to one clean surface and the other clean surface brought into contact with it within the tack free time stated opposite. For optimum bond strength, the thickness of the sealant joint should be a minimum of 1 mm.

The sealant will cure upon exposure to atmospheric moisture, ideally between 20 to 30  $^{\circ}\text{C}$  and 40% to 70% Relative Humidity. Time taken for cure will depend on the thickness of the joint, humidity and temperature. Joints should be left undisturbed for at

least 24 hours, but preferably longer to effect sufficient depth of cure. Full cure requires 7 days.

-50 °C / -58 °F Min Working Temp Tensile Strength **ISO 37** 2.5 N/mm2 / 363 psi Thermal Conductivity 0.4 W/mK **Electrical Properties** >457 V/mil Dielectric Strength (V/mil)

Storage Max Storage Temperature 40 °C / 104 °F Shelf Life 12 mths

"For pneumatic dispensing of 310 ml cartridges, the recommended pressure is 2.25 to 3.45 bar (40 to 50 psi). Dispensing pressure above the recommended limits may lead to gas bypassing the piston, causing spluttering at the nozzle and poor bead quality"

It is important to check the compatibility in premininary tests if unknown substrates are used.

# **Health & Safety**

## **Health and Safety**

Safety Data Sheets available on request.

CHT Adhesives are available in a variety packaging including cartridges and bulk containers. Please contact our sales department for more information.

**Revision Date** 26 May 2023

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